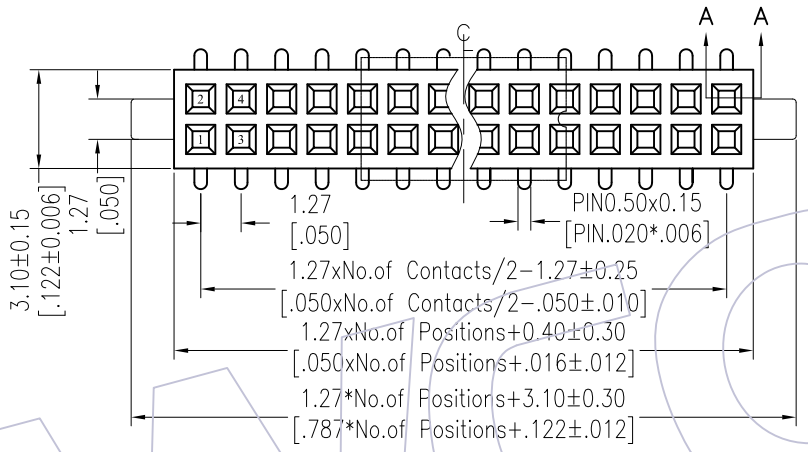
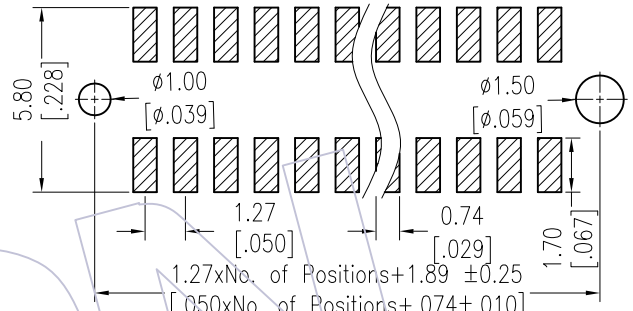
HSF

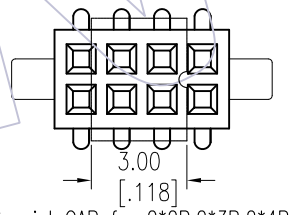
NOTES:
Current Rating: 1.0AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 500V AC/DC
Insulation Resistance: 1000MΩ Min
Operation Temperature: −40℃ to +105℃

Contact Material:Phosphor Bronze
Contact plating:Au Or Sn over Ni
Insulator Material:PA9T+30%GF UL94V-0



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



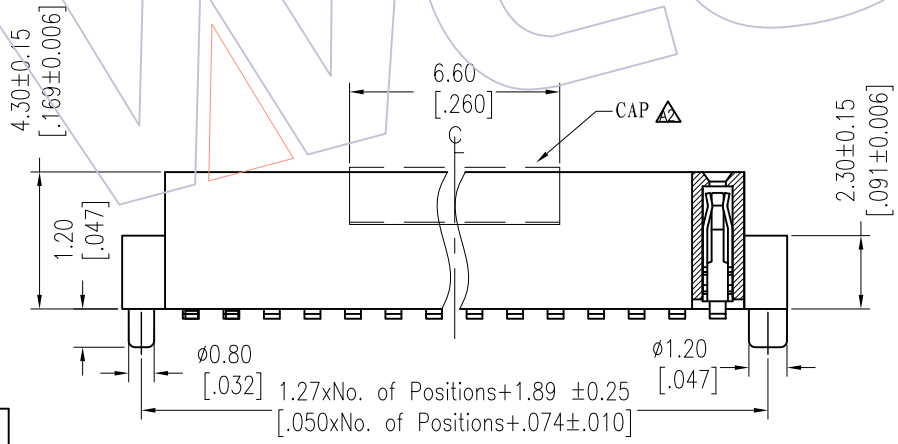


Special CAP for 2*2P,2*3P,2*4P

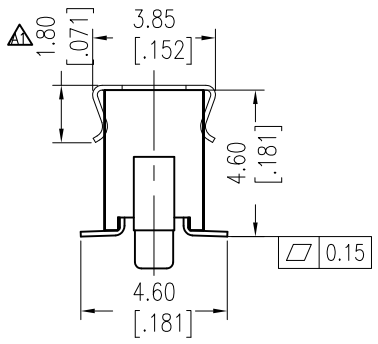
Ordering Information

2344-2 XX M XX CUN X 3

- XX: No.of Pins per Row: 02~50Pin
- XX: Contact Plating: G0=Gold Flash, G3=10μ"Gold, G4=15μ"Gold, G5=30μ"Gold, S0=Gold Flash/Tin, S3=10μ"Gold/Tin, S4=15μ"Gold/Tin, S5=30μ"Gold/Tin, SN=Tin
- X: Packing: T=Tube, P=Tube+CAP, R=Tape&Reel+CAP



SECTION A−A



Item	Pitch	Mating
Standard	1.27	1310/1315/1320/3131/3133/3100
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A2	2014/12/30	Modify CAP	------
A1	2013/08/21	Modify cap 2.00→1.80	------
A0	2012/07/09	NEW	------

OPERATION		DRAW	DATE	SCALE	FIT
X.X	±0.40	Wang	2014/12/30	UNIT	mm
X.XX	±0.25	CHECK	DATE	SIZE	A4
X.XXX	±0.15			SHEET	1/1
Angle	± 3°	APPROVE	DATE	PROJ.	
DIM	TOL				

PART NO. 2344-2XXMXXCUNX3

TITLE: FH1.27mm DUAL SMT WITH DIFFERENT POST H=4.30

Customer NO.